



PRODUCT DATASHEET



- Ceramic High Power
- ▶ 3939 1.53t Series
- ► UV (250~260nm)





N0Q56S54Z

APPLICATIONS:

- Disinfection
- Sterilization
- Bio-Analysis
- Detection
- Sensor Light
- Fluorescent Spectroscopy

3939 1.53t Series



FEATURES:

- Package: Ceramic SMT Package with Quartz Glass Lens
- Forward Current: 100mA
- Forward Voltage (typ.): 7.0V
- Radiant Power (typ.): 12mW@100mA
- Colour: Ultraviolet (UV)
- Wavelength: 250~260nm
- Viewing angle: 120°
- Materials:
 - Die: InGaN
 - Resin: Quartz Glass (Water Clear)
 - L/F: AIN
- Junction Temperature: +65°C
- Storage Temperature: -40~+80°C
- Grouping parameters:
 - Forward voltage
 - Radiant power
 - Peak Wavelength
- Soldering methods: Reflow soldering
- MSL: Level 4 according to J-STD020
- Packing: 12mm tape with min.100pcs/reel, ø180mm (7")







Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Maximum Forward Current	Імах	100	mA
Junction Temperature	Tj	65	°C
Thermal Resistance Junction to Solder Point	Rтнлs	15	°C/W
Storage Temperature	T _{STG}	-40~+80	°C
Solder Temperature	T _{SOL}	245	°C

Electrical & Optical Characteristics (Ta=25°C)

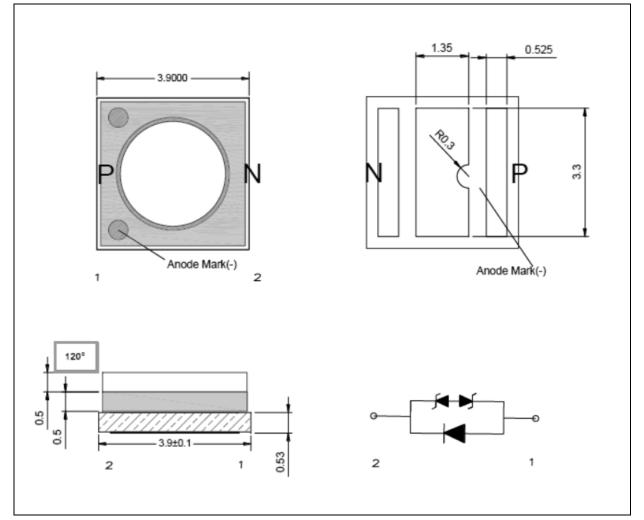
Parameter	Symbol	Values			Unit	Test
	Symbol	Min.	Тур.	Max.	Omt	Condition
Forward Voltage	V_{F}	5.0		9.0	V	I _F =100mA
Radiant Power	Po	8		16	mW	I⊧=100mA
Wavelength	Wp	250		260	nm	I⊧=100mA
Viewing Angle	20 _{1/2}		120		deg	l⊧=100mA

 $1. \qquad \text{Radiant Power (P_0) \pm 10\%, Forward Voltage (V_F) \pm 0.2V, Viewing angle(2\theta_{1/2}) \pm 10^{\circ}, Wavelength (nm) \pm 2nm}$



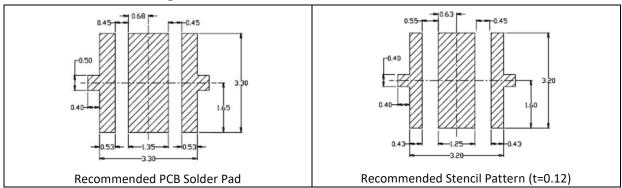


Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.13 mm with angle tolerance $\pm 0.5^{\circ}$.





Forward Voltage Classifications (I_F = 100mA):

Code	Min.	Max.	Unit
V1	5.0	7.0	V
V2	7.0	9.0	V

Radiant Power Classifications (I_F = 100mA):

Code	Min.	Max.	Unit
H1	8	16	mW

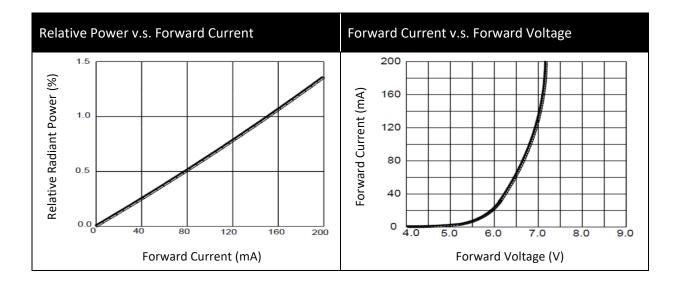
Wavelength Classifications (I_F = 100mA):

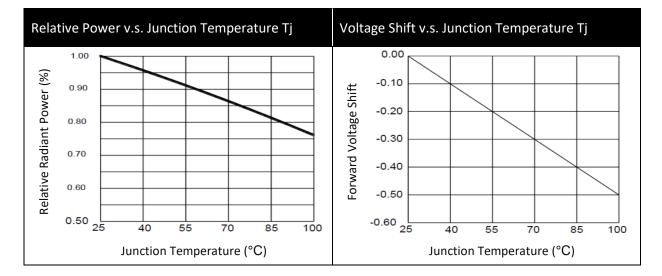
Code	Min.	Max.	Unit
W25	250	260	nm

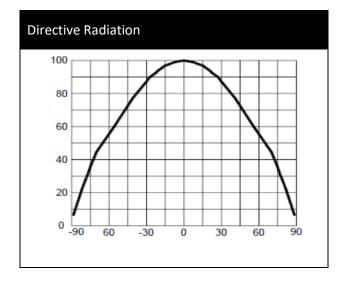




ELECTRO-OPTICAL CHARACTERISTICS:



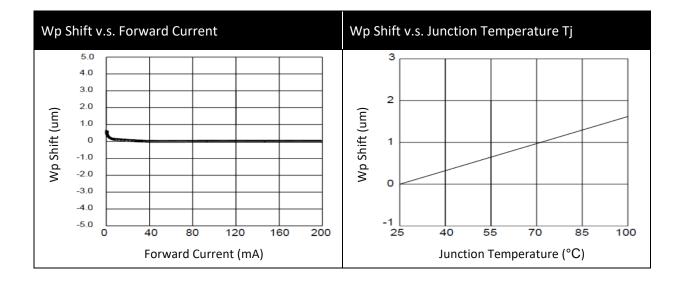








ELECTRO-OPTICAL CHARACTERISTICS:

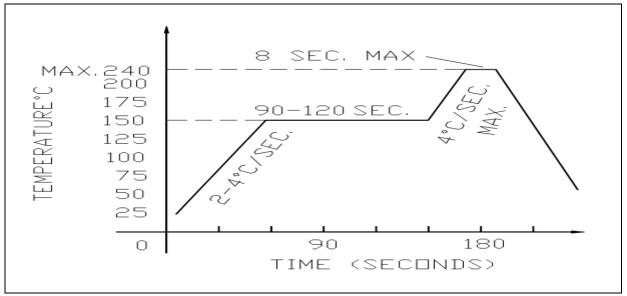






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



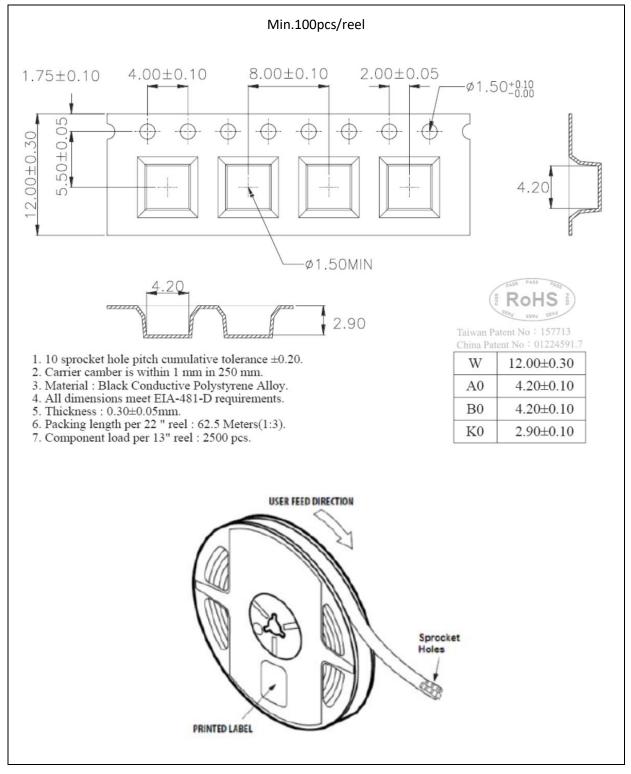
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Recommended reflow temperature 240°C. Maximum soldering temperature should be limited to 245°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.





Reel Dimension:



8





Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 72 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

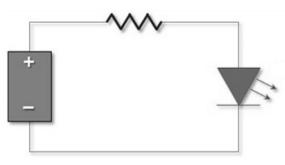
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 12hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.





REVISION RECORD:

Version	Date	Summary of Revision
A1.0	21/11/2020	Datasheet set-up.
A1.1	11/11/2021	New datasheet format.

